

Introduction

IEC 61508 is an international standard governing a range of electrical, electromechanical and electronic safety related systems. It defines the requirements needed to ensure that systems are designed, implemented, operated and maintained at the required Safety Integrity Level (SIL). Four SIL levels have been defined to indicate the risks involved in any particular system, with SIL4 being the highest risk level.

At the heart of the majority of safety related systems nowadays is a sophisticated and often highly integrated Microcontroller (MCU). An integral part of meeting the requirements of IEC61508 is the ability to verify the correct operation of critical areas of the MCU.

The Renesas Diagnostics Software is designed for use with the Synergy S3 Microcontroller Family. Tests are provided for coverage of the following critical areas of the MCU's operation: The Central Processing Unit (CPU), the Embedded Flash ROM memory, the Embedded RAM memory, the main clock structure (Main clock oscillator, PLL, MUX generating ICLK), and Vcc power supply.

The code was developed using the functional safety version 8.23.1.17132 of the IAR Embedded Workbench for ARM, which is certified by the TÜV SÜD certification body, and in accordance with IEC61508:2010 for use in safety related applications up to SIL3 level. This is also the systematic capability for the Renesas Diagnostics Software described in this document.

Please note that in the code some pragmas have been added in the shape of comments (e.g. `/*LDRA_INSPECTED 90 S Basic type declaration used. */`) which have been used to mark code lines flagged to potentially violate a specific MISRA rule but judged as safe. See Annex C for details about the pragmas inserted.

Target Device

Synergy S3 Series MCU

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1. Common Terminology

This section defines some common terms and acronyms used throughout the document and provides references to other relevant Renesas documentation.

1.1 Acronyms

Table 1.1 Terminology and acronyms

| Acronym | Description |
|---------|-------------------------|
| CRC | Cyclic Redundancy Check |
| LUT | Look Up Table |
| TS | Test Segment |
| TS_ID | Test Segment Identifier |
| WD | Watch Dog |

2. Compiler Environment

The Diagnostic Software code was developed using the functional safety version 8.23.1.17132 IAR Embedded Workbench for ARM, which is certified by the TÜV SÜD certification body, for use in safety related applications up to level SIL3.

2.1 C Type Implementation

Integer C variables are assumed to be 32-bit implemented. Please, make sure that int type has to be represented in 32-bit format on the target environment.

2.2 IAR Environment Settings

The IAR environment should be set up as specified in Table 2.1.

Table 2.1 IAR project options

| ID | Category | Sub-category | Setting description | Comment |
|----|-----------------|---|--|---|
| 1 | General Options | Target | <ul style="list-style-type: none"> Device := Renesas R7FS3A77C (S3A7) Renesas R7FS3A678 (S3A6) Renesas R7FS3A37A (S3A3) Renesas R7FS3A17C (S3A1) Floating-point, Size of type 'double' := 32bits Subnormal numbers := Treat as zero Int, Size of type 'int' := 32bits Data model := Far | |
| 2 | General Options | Library Configuration | <ul style="list-style-type: none"> Library := Normal DLIB | |
| 3 | General Options | Stack/Heap | <ul style="list-style-type: none"> Privileged mode stack size := 0x1000 | Consider this setting as typical. The stack size has to be greater than the one specified in the Resources Usage section. |
| 4 | C/C++ Compiler | Language1 | <ul style="list-style-type: none"> Language := C C dialect := C99 Language conformance := Standard with IAR extensions | |
| 5 | C/C++ Compiler | Language2 | <ul style="list-style-type: none"> Floating-point semantics := Strict conformance | |
| 6 | C/C++ Compiler | Code | <ul style="list-style-type: none"> Align functions := 1 no alignment | |
| 7 | C/C++ Compiler | Optimizations | <ul style="list-style-type: none"> Level := None | |
| 8 | Assembler | Language | <ul style="list-style-type: none"> User symbols are case sensitive | |
| 13 | Linker | Library | <ul style="list-style-type: none"> Automatic runtime library selection | |
| 14 | Linker | Others Sub-category | For RAM test specific testing see Section 4 For ROM test specific testing See section 5. | |
| 15 | Build | For RAM test specific testing see Section 4 | | |

| | |
|---------|---|
| Actions | For ROM test specific testing See section 5 |
|---------|---|

3. CPU Software Test

3.1 Test Objectives

The objective of the CPU Software Test is to verify the correct functionality of the CPU by adopting a mainly instruction based diagnosis, with the aim to detect permanent hardware failures of the CPU Core.

All instructions, with the only exceptions being the BKPT, SEV, WFE, WFI and DMB instructions, are used in the CPU core testing scheme.

Please see Document Reference [1] for the complete list of instructions. However, please note the primary aim is not to test individual instructions but to detect a hardware failure of the CPU core.

3.2 Software Structure

The software structure provides for two different levels of functions calls

- a. The first level is the user interface function named *coreTest*.
- b. The second lower level functions are named *testSegment* that are called by *coreTest*.

The *testSegment* functions execute the actual diagnostic of the core, whilst the *coreTest* allows the user to select and run of one or more of the *testSegment* functions in sequence and to collect the diagnostic results.

Up to 20 *testSegment* functions are available; from *testSegment0* to *testSegment19*. Table 3.1 below provides an overview of the *testSegment* functions.

Two types of *testSegment* functions are defined.

- *testSegment* of type “Fixed”:
 - operand data necessary to stimulate the core and run these functions is embedded in the code.
- *testSegment* of type “LUT”:
 - these functions can be called with different operand data taken from a Look Up Table.

Table 3.1 Test Segment Overview

| TS_ID | Function Name | Objective of the Test | Test Segment Type |
|-------|---------------|---|-------------------|
| TS00 | testSegment00 | Testing of Jump instructions (using control flow) | Fixed |
| TS01 | testSegment01 | Logical instructions as AND, EOR, NOT, BIC | Fixed |
| TS02 | testSegment02 | Bit-level manipulation and test instructions as REVERSE, TEQ | Fixed |
| TS03 | testSegment03 | Floating point multiply instructions | LUT |
| TS04 | testSegment04 | Floating point addition/subtractions instructions plus additional floating points conversion instructions as VCVT and VCVTB | LUT |
| TS05 | testSegment05 | Floating point division instructions plus additional floating point instruction as VABS, VNEG and VCVT | LUT |
| TS06 | testSegment06 | Saturating instructions plus additional floating points conversion instructions as VCVT | Fixed |
| TS07 | testSegment07 | CPU Control Registers | Fixed |
| TS08 | testSegment08 | Integer multiply instructions using LUT data with MULS. (32bit results) | LUT |
| TS09 | testSegment09 | Divide instructions | LUT |
| TS10 | testSegment10 | Load and store using GPR only | Fixed |
| TS11 | testSegment11 | Floating point normalize and denormalized tests | Fixed |
| TS12 | testSegment12 | Load and store using floating point data registers plus floating point read port 0 and 1 tests | Fixed |
| TS13 | testSegment13 | Integer multiply using LUT data with UMUL and SMUL instruction. (64bit result) | LUT |
| TS14 | testSegment14 | FPU control register plus FPU extension registers and VSUB and conversion instruction | Fixed |

| TS_ID | Function Name | Objective of the Test | Test Segment Type |
|-------|---------------|---|-------------------|
| TS15 | testSegment15 | Shift and rotate instructions | Fixed |
| TS16 | testSegment16 | Integer addition and subtract instructions | LUT |
| TS17 | testSegment17 | Bit field instructions plus internal core register tests | Fixed |
| TS18 | testSegment18 | Packing and unpacking instructions | Fixed |
| TS19 | testSegment19 | Floating point square root plus internal core register tests. | LUT |

Table 3.2 reports the association of the execution progress versus the *testSegment* to be executed and the related data set for LUT *testSegment*.

The execution order of the Test Segments (TSs) follows the order defined in Table 3.2 and the *coreTestInit* function is used to initialize the sequence.

The concept is to allow the user to select how many steps shall be performed by the *coreTest* function, so that the user is able to control the execution progress of the CPU core test. In this way, in case the user has specific execution time constraints, he can decide how many steps execute in order to fulfil the execution time constraints

Table 3.2 Execution steps association w.r.t. *testSegment*

| Execution progress | Test Segment | Dataset (if applicable) |
|--------------------|---------------|-------------------------|
| 0 | testSegment00 | NA |
| 1 | testSegment01 | NA |
| 2 | testSegment02 | NA |
| 3 | testSegment03 | Float32_MUL_set0 |
| 4 | testSegment04 | Float32_ADD_set0 |
| 5 | testSegment05 | Float32_DIV_set0 |
| 6 | testSegment06 | NA |
| 7 | testSegment07 | NA |
| 8 | testSegment08 | Int32_MUL_set0 |
| 9 | testSegment09 | Int32_DIV_set0 |
| 10 | testSegment10 | NA |
| 11 | testSegment11 | NA |
| 12 | testSegment12 | NA |
| 13 | testSegment13 | Int32_UMUL_set0 |
| 14 | testSegment14 | NA |
| 15 | testSegment15 | NA |
| 16 | testSegment16 | Int32_ADD_set0 |
| 17 | testSegment17 | NA |
| 18 | testSegment18 | NA |
| 19 | testSegment19 | Float32_SQRT_set0 |
| 20 | testSegment08 | Int32_MUL_set1 |
| 21 | testSegment08 | Int32_MUL_set2 |
| 22 | testSegment09 | Int32_DIV_set1 |
| 23 | testSegment09 | Int32_DIV_set2 |
| 24 | testSegment16 | Int32_ADD_set1 |
| 25 | testSegment16 | Int32_ADD_set2 |
| 26 | testSegment03 | Int32_MUL_set0 |
| 27 | testSegment03 | Int32_MUL_set1 |

| | | |
|----|---------------|----------------|
| 28 | testSegment03 | Int32_MUL_set2 |
| 29 | testSegment04 | Int32_ADD_set0 |
| 30 | testSegment04 | Int32_ADD_set1 |
| 31 | testSegment04 | Int32_ADD_set2 |

3.2.1 API and CPU Test Environment

All the *testSegment* functions are called through a main interface function named *coreTest*.

The *coreTest* function signature is defined as follows:

```
void coreTest(uint8_t steps, const uint8_t forceFail, uint32_t *result);
```

Table 4 describes in more detail the input and output of each function.

Please note by using the *forceFail* input it is possible to force the function to fail that is to return an error value. This type of software fault injection feature allows for testing of higher level fault handling mechanisms, specified at the application level.

Table 3.3 coreTest Interface

| Table ID | Parameter type | C type | Name | Description |
|----------|----------------|--------------------------|-----------|---|
| 1 | Input | unsigned int 8 bit | steps | Specify how many execution progresses have to be executed. Note that each execution of a LUT TS with a specific dataset count for 1 step (see Table 3.2 for details about association of <i>testSegment</i> to execution progress). Valid range of steps parameter is: 0 < steps < TOT_TESTSEGMENTS, where TOT_TESTSEGMENTS is the maximum number of execution progresses that could be performed in one run. |
| 2 | Input | const unsigned int 8 bit | forceFail | When set to 0 forces the function to fail generating a failure signature that is the inverted value of the correct expected signature. All other values do not have any effect on the function behavior. |
| 3 | Output | *unsigned int 32 bit | result | Global pass/fail result of all executed TSs: <ul style="list-style-type: none"> - 0 If at least one executed testSegment failed - 1 If all executed testSegments passed. - 2 If steps input parameter is out-of-range (see Table 3.2 for details about the valid range). |

In order to correctly use *coreTest* function two other functions are given: “*coreTestInit*” function and “*getcoreTestStatus*” function.

The first one is the initialization function, written in C programming language, whose signature is defined as follows.

```
void coreTestInit(void)
```

The function has no input or output parameters, since it just initializes the different data structures needed for the correct execution of *coreTest*; in particular it resets the pointer to the next execution progress to be executed. As a consequence, after *coreTestInit* is called, the next TS to be executed will be the testSegment00 (see Table 3.2).

The second function offers to the user the possibility to get the next execution progress which will be executed in the next call of *coreTest* function.

The function is written in C programming language and its signature is defined as follows.

```
uint8_t getcoreTestStatus(void)
```

Table 3.4 describes in more details the output of the function.

Table 3.4 getcoreTestStatus Interface

| Table ID | Parameter type | C type | Name | Description |
|----------|----------------|--------|------|-------------|
|----------|----------------|--------|------|-------------|

| Table ID | Parameter type | C type | Name | Description |
|----------|----------------|---------------------|------|---|
| 1 | Output | *unsigned int 8 bit | n.a. | It indicates the next execution step that will be executed. |

test Segments functions are implemented with ARM Cortex-M4 assembly code with a C code interface.

Note that the need for an HW low level control makes the use of assembler necessary, for instance when calling specific assembly instructions with specific parameters.

Since it is possible to have two types of *testSegments* (Fixed or LUT) then we have the two following types of function signatures:

- a. “Fixed”
 - *void testSegmenty (const uint8_t forceFail, uint32_t *result) with y=00, 01, 02, 06, 07, 10, 11, 12, 14, 15, 17, 18.*
- b. “LUT”
 - *void testSegmentx (const uint8_t forceFail, uint32_t *result, const uint32_t *StartDataSet, const uint32_t GoldSign) with x= 03, 04, 05, 08, 09, 13, 16, 19.*

Table 3.5 describes in more details input and output of the functions.

Table 3.5 testSegment Interface

| Table ID | testSegment type | Parameter type | C type | Name | Description |
|----------|------------------|----------------|-----------------------------|--------------|--|
| 1 | LUT or Fixed | input | const unsigned int 8 bit | forceFail | When set to 0 force the TS to fail generating a failure signature that is a NOT-inverted value of the proper signature. All other values do not have any effect on the function behavior. |
| 2 | LUT | input | const unsigned int 32 bit * | StartDataSet | Start address of the Look Up Table for the selected dataSet. |
| 3 | LUT or Fixed | output | const unsigned int 32 bit | GoldSign | Result of signature value. |
| 4 | LUT or Fixed | output | unsigned int 32 bit * | result | Pass/fail result of TS execution 0 If TS failed 1 If TS passed. |

3.3 Software Integration Rules

This section provides guidelines for how to integrate the CPU test software within the user’s own project.

3.3.1 Code Integration

3.3.1.1 Environment for *coreTest* call

Follow the instructions below to call the *coreTest* function.

1. Include *coreTest.h*
2. Create a variable to hold the result of the test as *uint32_t result*. Then the address of the variable is passed to *coreTest* function (see the example below).
3. Define input variables to pass to *coreTest*
 - a. *uint8_t steps*
 - b. *uint8_t forceFail*
 - c. *uint32_t *result*

Example

```
#include "coreTest.h"

uint8_t steps=1;
uint32_t result=0;
uint8_t forceFail = 11;

void main
{
    coreTestInit(); //init index

    /* Launch the core test function in order to perform Diagnosis SW*/
    coreTest(steps, forceFail, &result);
    if(result != 1) {
        errorHandler(); /*Fault handling*/
    }
}
```

After *coreTest* function returns, fault detection can be done by checking the *result* output value as shown in the example above.

A complete example of the *coreTest* function, which calls all *testSegment* is provided in

Appendix B – CPU Test Example.

3.3.2 Compiler Warnings

Please note that in Test Segment 17 two warnings are raised by the compiler respectively at rows 278 and 286. They are related to the utilization of the stack pointer as source register. The warnings come from the fact that the SP cannot assume an a-priori well known value, since it strongly depends on the application. Therefore its utilization could lead to unpredictable behaviors.

Anyway this is not the case of this SW, because only the offset of the SP between two pre-defined assembly instruction blocks is used (accumulated in the signature). Since the offset value is fixed (this part of code is critical, then exceptions are disabled in it), the SW behavior is completely predictable.

3.3.3 Usage Conditions

Table 3.6 summarises usage conditions.

Table 3.6 Conditions of use

| ID | Topic | Constraint | Description |
|----|---------------------|--|---|
| 1 | Interrupt | Avoid corruption of function context. | When interrupting the Diagnostic SW the context of all General Purpose Registers, system register, including APSR and FPSCR, have to be saved and restored once returning from interrupt handling. See Document Reference [1] for details of the CPU register definitions. |
| 2 | CPU mode | Correct execution of the SW. | Launch Diagnostic SW in privileged mode |
| 3 | Stack | Correct execution of the SW. | Use Main Stack Pointer as stack pointer for the function call. |
| 4 | Diagnostic coverage | Execute all the <i>coreTest</i> steps during application SW execution. | If a subset of <i>coreTest</i> steps are executed from the CPU Test the overall diagnostic coverage of the CPU Test will be lower than the value achieved with the full CPU Test. |
| 5 | Interrupt | Avoid corruption of function context. | The following condition applies if there is an Interrupt Service Routine making use of floating point instructions. Inside the application code isolate in a critical section with interrupt disabled the part of the code making use of floating point instructions. |

3.4 Define Directives for Software Configuration

No specific define directives are needed.

3.5 Software Package Description

This section details how to identify the supplied software package and also provides a description in tabular format for each design file type.

3.5.1 Identification and Contents of Package

The Software package version is identified as follows:

- Revision 1.0.2
- File list

Table 3.7 CPU Software Test Package and related MD5 signatures.

| Nome File | MD5 Signature |
|---------------|----------------------------------|
| closeTest.asm | 50c2d658a53cbd2cc01dd65c96060b81 |
| coreTest.c | d73b1c130c736f21b365fe82bf4a49cc |
| coreTest.h | 354338ad61d6d344ad42a6582b46454c |
| globVar.h | 0eec1261c9ba66b25214ebd3b5729b13 |
| initTest.asm | 86d528b427395364b9d071b3991aba47 |

| | |
|-------------------|-----------------------------------|
| testSegment00.asm | ffa26ea3e0695a1737c81167ab95c140 |
| testSegment00.h | e7a098b362787264230173ab43907ab6 |
| testSegment01.asm | 828822cd7a811b3701ff7722053aa1e6 |
| testSegment01.h | 4e0d0de4d40176a2747de0217ad0d2d8 |
| testSegment02.asm | 718e51540781736c882ca29ee847a785 |
| testSegment02.h | 65884aca0f87bfb1a23f0f2a29ba88f6 |
| testSegment03.asm | 64fadf7d06a0acf9c030e19d734c0bd9 |
| testSegment03.h | 7e406791d29fe3289887ed60af5fc1f8 |
| testSegment04.asm | 4e1e681a7d77b6c080b125de333e3f7c |
| testSegment04.h | 8825b9d1ca2bd456c34d8523899f73db |
| testSegment05.asm | 354a456ce9e98ca5cd5b52c280b17745 |
| testSegment05.h | 8a97222eec7fae0a2594514df8d4ad2b |
| testSegment06.asm | c172c5123942a5c3c7a4db0741676afa |
| testSegment06.h | 36efb828af9b33ef3ef360efd717b510 |
| testSegment07.asm | df3a697e716e3dbdb82a5f4a40d924a4 |
| testSegment07.h | 688ecb7e16f64129b35f7696a1ad7c5d |
| testSegment08.asm | 1a2fb67f94d0bc36ce923c064e7cc86a |
| testSegment08.h | fa8e2c6904513c6067d58011292bb297 |
| testSegment09.asm | 2187925108eeeea813b93076dc4d64d4a |
| testSegment09.h | 2b0056b7fd5917187ec99846d3503f9c |
| testSegment10.asm | fb8018e88175106feab08d2d198d4ca8 |
| testSegment10.h | c61233702c83f65b3346a766513053b1 |
| testSegment11.asm | 6c314801590bad445abbe0503b3485a1 |
| testSegment11.h | 22c072c0375dd92a7dd002c4af1378f0 |
| testSegment12.asm | 313194fda5acf288922b9d54c6f21702 |
| testSegment12.h | 9d01d6d1a7c2eba4bc6ab14c169f4315 |
| testSegment13.asm | 40ee680270a3a486bbab1810b8723aea |
| testSegment13.h | 76c207764c711ee676ec70efa063bffd |
| testSegment14.asm | 36a61640cf1cad6a46a842b9c63a42eb |
| testSegment14.h | 663e49cef53ab71bcc5036f50e3b3587 |
| testSegment15.asm | 1dfe95ffbcf91bfafc0941a668160836 |
| testSegment15.h | 8a96899cecd157494d23105988da29 |
| testSegment16.asm | 0a9753495c4ae7f9724f024012ba8604 |
| testSegment16.h | 27a814c49a3d3de951eebf3b44d0646e |
| testSegment17.asm | 5644dc9a9f6a1d1640ae4eb3a063c4dd |
| testSegment17.h | 7fd2d0b9359f06ee69f910b82943846f |
| testSegment18.asm | f1dac4d00c4172439b02ad3d4aebb88b |
| testSegment18.h | 30bfeb664848f071c8afe6be4c7495a6 |
| testSegment19.asm | dd61f120b9e697b22f1ca723e710615d |
| testSegment19.h | 8d88b5d41646c51b072e29cfa4723923 |
| testSegmentMgm.c | 9024072e409bb0f57ce385324550c77f |
| testSegmentMgm.h | 0f5334d44e33ca6d734a609410c3da25 |

3.5.2 Description of Design Files

Table 3.8 Design files

| Table ID | File Name | Description |
|----------|-------------------------------------|---|
| 1 | globVar.h | This file contains the compile option definitions, through which it is possible to select which TSs have to be included in the SW. This file also contains the definition of the LUT, signature vector sizes and other constants. |
| 3 | coreTest.h | This file contains the API of the diagnostic SW. In particular contains the coreTest function declaration to be called by the application SW. |
| 4 | coreTest.c | This file contains the definition of coreTest function. |
| | testSegmentMgm.h | This file contains the API of the TS execution progress management. In particular contains the testSegmentMgm function declaration to be called by the coreTest function. |
| | testSegmentMgm.c | This file contains the definition of testSegmentMgm function. |
| 5 | testSegmentxx.h with xx=0,...,19. | This file contains the declaration of the <i>testSegment</i> functions. |
| 7 | testSegmentxx.asm with xx=0,...,19. | This file contains the assembler definition of the <i>testSegment</i> function. |
| 8 | initTest.asm | This file contains the TS signature accumulation register initialization. |
| 9 | closeTest.asm | This file finalizes the TS and states whether it is passed or not. |

Table 3.9 - Design files

3.6 Resources Usage

Table 3.10 provides an overview of the memory resources used by the code.

Take care that resources related to the *main* file are not part of the *coreTest* function and then not included.

Maximum stack usage is 0 bytes.

Note that no dynamic memory allocation is implemented.

Table 3.10 Memory resources

| Module | ROM | | RAM |
|------------------|--------------|--------------|-----------------|
| | Code (bytes) | Data (bytes) | rw data (bytes) |
| coreTest.o | 960 | 6704 | 0 |
| testSegmentMgm.o | 36 | 0 | 1 |
| initTest.o | 278 | 0 | 0 |
| closeTest.o | 28 | 0 | 0 |
| testSegment00.o | 1044 | 9 | 0 |
| testSegment01.o | 1962 | 0 | 0 |
| testSegment02.o | 844 | 0 | 0 |
| testSegment03.o | 2120 | 0 | 0 |
| testSegment04.o | 1838 | 0 | 0 |
| testSegment05.o | 1656 | 0 | 0 |
| testSegment06.o | 1908 | 0 | 0 |
| testSegment07.o | 604 | 0 | 0 |
| testSegment08.o | 2398 | 0 | 0 |
| testSegment09.o | 188 | 0 | 0 |
| testSegment10.o | 1340 | 0 | 0 |
| testSegment11.o | 2136 | 0 | 0 |

| Module | ROM | | RAM |
|----------------------|--------------|--------------|-----------------|
| | Code (bytes) | Data (bytes) | rw data (bytes) |
| testSegment12.o | 6320 | 0 | 0 |
| testSegment13.o | 976 | 0 | 0 |
| testSegment14.o | 2056 | 0 | 0 |
| testSegment15.o | 1642 | 0 | 0 |
| testSegment16.o | 3908 | 0 | 0 |
| testSegment17.o | 9254 | 0 | 0 |
| testSegment18.o | 1266 | 0 | 0 |
| testSegment19.o | 1578 | 0 | 0 |
| TOTAL (bytes) | 46340 | 6713 | 1 |

Table 3.11 details the execution time for each *testSegment* for all valid values of *dataSet*. Interrupt disable time is also reported when applicable.

Table 3.11 Execution time

| testSegment | dataSet | Execution time [clock cycles] | Execution time @48Mhz clock [us] | Maximum interrupt Disable Time [clock cycles] | Maximum interrupt Disable Time @48Mhz clock [us] |
|---------------|------------------|-------------------------------|----------------------------------|---|--|
| testSegment00 | | 679 | 14,15 | 0 | 0 |
| testSegment01 | | 801 | 16,69 | 0 | 0 |
| testSegment02 | | 499 | 10,40 | 0 | 0 |
| testSegment03 | Float32_MUL_set0 | 3129 | 65,19 | 47 | 0,98 |
| testSegment03 | Int32_MUL_set0 | 3087 | 64,31 | 47 | 0,98 |
| testSegment03 | Int32_MUL_set1 | 3143 | 65,48 | 47 | 0,98 |
| testSegment03 | Int32_MUL_set2 | 2987 | 62,23 | 47 | 0,98 |
| testSegment04 | Float32_ADD_set0 | 4833 | 100,69 | 48 | 1 |
| testSegment04 | Int32_ADD_set0 | 2225 | 46,35 | 48 | 1 |
| testSegment04 | Int32_ADD_set1 | 2223 | 46,31 | 48 | 1 |
| testSegment04 | Int32_ADD_set2 | 2231 | 46,48 | 48 | 1 |
| testSegment05 | Float32_DIV_set0 | 2717 | 56,60 | 62 | 1,29 |
| testSegment06 | | 757 | 15,77 | 35 | 0,73 |
| testSegment07 | | 479 | 9,98 | 23 | 0,48 |
| testSegment08 | Int32_MUL_set0 | 1757 | 36,60 | 0 | 0 |
| testSegment08 | Int32_MUL_set1 | 1799 | 37,48 | 0 | 0 |
| testSegment08 | Int32_MUL_set2 | 1739 | 36,23 | 0 | 0 |
| testSegment09 | Int32_DIV_set0 | 1443 | 30,06 | 0 | 0 |

| testSegment | dataSet | Execution time [clock cycles] | Execution time@48Mhz clock [us] | Maximum interrupt Disable Time [clock cycles] | Maximum interrupt Disable Time @48Mhz clock [us] |
|---------------|-------------------|-------------------------------|---------------------------------|---|--|
| testSegment09 | Int32_DIV_set1 | 1147 | 23,90 | 0 | 0 |
| testSegment09 | Int32_DIV_set2 | 1289 | 26,85 | 0 | 0 |
| testSegment10 | | 813 | 16,94 | 0 | 0 |
| testSegment11 | | 1097 | 22,85 | 50 | 1,04 |
| testSegment12 | | 4433 | 92,35 | 56 | 1,165 |
| testSegment13 | Int32_UMUL_set0 | 1517 | 31,60 | 0 | 0 |
| testSegment14 | | 996 | 20,75 | 43 | 0 |
| testSegment15 | | 727 | 15,15 | 0 | 0 |
| testSegment16 | Int32_ADD_set0 | 2353 | 49,02 | 0 | 0 |
| testSegment16 | Int32_ADD_set1 | 2375 | 49,48 | 0 | 0 |
| testSegment16 | Int32_ADD_set2 | 2123 | 44,23 | 0 | 0 |
| testSegment17 | | 3059 | 63,73 | 27 | 0,56 |
| testSegment18 | | 621 | 12,94 | 0 | 0 |
| testSegment19 | Float32_SQRT_set0 | 3609 | 75,19 | 46 | 0,955 |
| Total | | 62687 | 1305,98 | 722 | 15,05 |

3.7 Requirements for Safety Relevant Applications

Table 3.12 lists requirements for usage in safety relevant applications.

Table 3.12 Safety relevant requirements

| ID | Topic | Sub-topic | Description |
|------|--------------------|----------------------|---|
| SW_1 | SW integration | Function return | On the return of <i>coreTest</i> evaluate the correctness of the execution by checking the value of "result". |
| SW_2 | SW integration | Function call | When calling the <i>coreTest</i> function more than once take care to use different variables to store the outcome of the function, specifically the test result. In case the same variable is used consider to initialize it to zero before executing subsequent runs of the function. |
| SW_3 | SW integration | Function environment | Before calling <i>coreTest</i> initialize to 0 the variable used by the function to return the <i>result</i> value. |
| PR_1 | Project management | User expertise | User has to have good expertise on embedded programming on the target MCU HW Synergy S3 series. Expertise on assembly programming and C level/assembly interface is requested. |

3.8 Diagnostic Fault Coverage and Watch Dog Usage

The Diagnostic coverage provided by the CPU Software Test considers that all *testSegments* of type Fixed are launched together with all *testSegments* of type LUT, each one called with all the supported values of the parameter *dataSet*, as detailed in Table 3.2.

In addition the coverage considers the contribution of a Watchdog. Indeed the use of the CPU Software Test has to be integrated with the use of a Watchdog and Table 3.13 outlines recommendations for its usage.

The necessity of integrating a Watchdog is related to the fact that some hardware faults will make the control flow of the software not to be followed and, in such conditions, the presence of a Watchdog will effectively detect such deviations.

Note also that the CPU Software Test embeds some control flow mechanisms which are required to trigger the activation of such faults. However, as stated above, the fault detection has to be completed by the presence of a Watchdog.

Table 3.13 Recommendations on Watchdog usage

| ID | Topic | Description | Comment |
|----|------------|--|---------|
| 1 | WD refresh | Consider a control flow monitoring for the WD refresh function: the refresh is done only if the control flow mechanism (e.g. proper value of global variable) is not respected. | |
| 2 | WD refresh | Consider a strategy as the following: activate the WD refresh only if all the main tasks having a predictable and periodic timing schedule of the application SW are called in the proper order. | |

4. RAM Software Test

4.1 Test Objectives

The objective of the RAM Software Test is to verify the embedded RAM memory of the MCU.

The main features of the software tests are as follows.

- a. Whole memory check including stack(s).
 - Memory size programmable at compile time
- b. Block-wise implementation of the test.
 - Size of the block programmable at compile time
- c. Supports of two test algorithms
 - Extended March C-
 - WALPAT.
- d. Word-wise implementation of the test algorithms where the elementary cell under test is considered to be made up by 32 bits width.
- e. Support for destructive and non-destructive memory testing.

Please note that information regarding the test algorithms is provided in Appendix B – CPU Test Example.

4.2 API and RAM Test Environment

A RAM block test is called through a main interface function named *testRAM*. The *testRAM* function signature is defined as follows:

```
void testRAM(unsigned int index, unsigned int selectAlgorithm, unsigned int destructive)
```

Table 4.1 below describes in more detail the function interface.

Table 4.1 testRAM Interface

| Table ID | Parameter type | C type | Name | Description |
|----------|----------------|--------------|-----------------|--|
| 1 | Input | unsigned int | index | Specify RAM block under test: from 0 to <i>numberOfBUT-1</i> . |
| 2 | Input | unsigned int | selectAlgorithm | Specify algorithm to be run on the RAM block under test: <ul style="list-style-type: none"> - "0" runs Extended March C-algorithm - "1" runs WALPAT - Other values will produce an error return value (i.e. resultTestRam1 = resultTestRam2 = 0) |
| 3 | Input | unsigned int | destructive | Specify the kind of test: <ul style="list-style-type: none"> - "0" means non-destructive test is run, RAM block content is saved in the buffer; - "1" means destructive test is run. Once a memory block is tested with a destructive procedure its content is initialized with all zeros. |

As specified in Table 4.1 *index* indicates the specific RAM block to be tested using the algorithm specified by *selectAlgorithm*. Each RAM block has a size in terms of double words defined by *BUTSize*.

Valid values of *index* range between 0 and *numberOfBUT-1*.

numberOfBUT indicates the number of block in which the RAM is divided and it is derived by dividing the memory size by the size of the block specified by the *BUTSize* parameter.

Calling the function with an invalid value of the block index, that is greater than (*numberOfBUT-1*), will result in the return variables being set to 0 indicating a failed test.

4.3 Test Strategy

The scope of the RAM Software Test is to provide coverage across the whole embedded RAM, adopting a block-wise strategy.

The memory size and the block size are parameters the user can select based on the device and its application needs.

- *MUTSize*
 - This is the size of the memory under test expressed in number of double word.
- *BUTSize*
 - This is the size of the block under test in terms of number of double word
- *numberOfBUT*
 - This is the number of blocks to which the memory is divided.

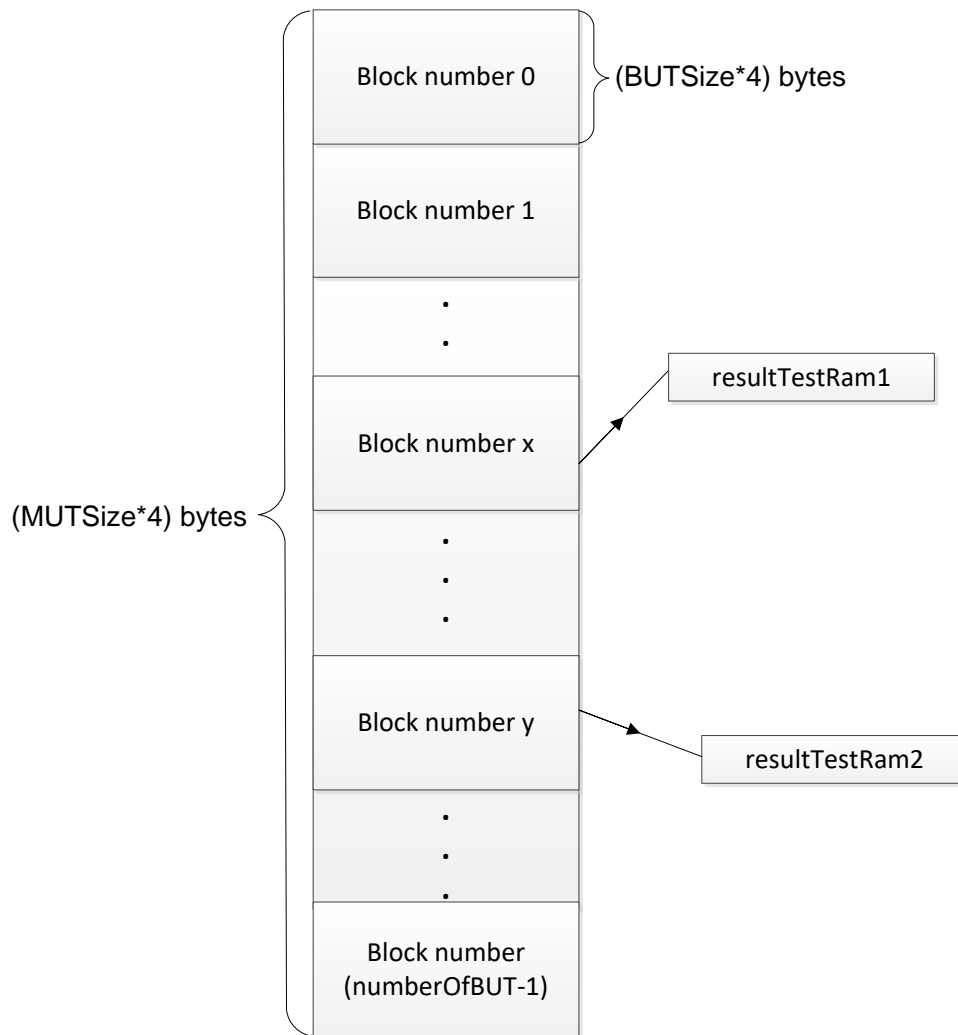


Figure 4.1 RAM block division

Figure 4.1 shows how the memory is divided into a number of blocks equal to *numberOfBUT*.

Each block is then identified with an index ranging from 0 to $(numberOfBUT-1)$.

Each block can be tested in a destructive or non-destructive manner.

In order to support non-destructive testing, one block of the RAM is used as a buffer to store the content of the block under test.

The buffer can be tested as well and this can be done with a destructive strategy before testing the other blocks.

A memory reserved area has to be defined for the buffer in order to preserve the integrity of the application software after running the test.

This can be obtained as follows

- a. Define the start address of the buffer
 - i. This can be done by assigning the label *addressBuffer* inside the file *testRAM.inc*; see Section 4.3 for an example of usage.
- b. Define IAR linker commands to reserve the memory buffer locations
 - i. Example of linker commands are provided in see section 4.4

The code stores the result of the test in two unused RAM locations accessible from the application software by using two variables: *resultTestRam1* and *resultTestRam2* (see Figure 4.1).

The result variables are located at fixed absolute addresses and they have to be placed into two different blocks.

This strategy has been selected to avoid the issue of not detecting a faulty block due to the fact that the result itself is stored in the same faulty block.

It is worth noting that these two variables are initialized each time the RAM test function is called and the user shall check their values only after having called RAM test function.

By allowing two copies of the test result to be stored into two different blocks, fault detection is still possible because at least one variable won't be stored inside a faulty block.

The location of the result variables can be fixed inside *testRAM.h*.

The application level user then has to check the values of the result variable after the test is completed.

Coding of the test result as follows

- i. *resultTestRam1 = resultTestRam2 = 1 implies the test is passed.*
- ii. *any other combinations means the test failed.*

An example of a test result check, in addition to definition of addresses for the result variables is provided in Section 4.3

4.4 Software Integration Rules

This section provides guidelines for how to integrate the RAM Test software within the user's own project.

4.4.1 Code Integration

4.4.1.1 Define Memory Size and Block Size

The user has to set the size of the RAM under test and the size of each of the blocks.

This information has to be provided by the directives present in *testRAM.h*.

BUTSize can have one of the values illustrated in Table 4.2 below.

Table 4.2 Relation between BUTSize and MUTSize

| BUTSize | Number of Blocks | Index |
|-----------------|------------------|-------------------------------|
| MUTSize/4 | 4 | 0, 1, 2, 3 |
| MUTSize/8 | 8 | 0, 1, 2, 3, 4, 5, 6, 7 |
| MUTSize/16 | 16 | 0, 1, 2, 3, 4, ..., 15 |
| MUTSize/32 | 32 | 0, 1, 2, 3, 4, ..., 31 |
| MUTSize/64 | 64 | 0, 1, 2, 3, 4, ..., 63 |
| ... | ... | ... |
| MUTSize/MUTSize | MUTSize | 0, 1, 2, 3, 4, ..., MUTSize-1 |

Below is a worked example for a 192Kbyte RAM divided in blocks of 1Kbyte size each.

```
//size of the RAM Memory Under Test: 192KB = 192 * 1024 bytes = 196608bytes = 49152double words
#define MUTSize      49152
//size of the Block of RAM Under Test of 1KB
#define BUTSize      (MUTSize/192)
```

4.4.1.2 Reserve and Place Buffer

In case the user wants to perform non-destructive tests, it is needed a buffer memory area.

A buffer area can be reserved using the IAR linker configuration file (.icf file) and defining a variable *buffer* in the application code.

Assuming the buffer size has to be 1Kbyte (then specify 1024 bytes in hexadecimal format 0x400) and the starting address of the buffer block is 0x2002FC00, then add the following two instructions:

1. *//RAM_TEST:BufferStorage definition*
2. *define block BufferStorage with alignment = 1, size = 0x400 { };*

3. *place at address mem: 0x2002FC00{ block BufferStorage };*

In the file *testRAM.inc* make sure to align the labels *addressBuffer_t* and *addressBuffer_w* to the buffer address, in particular to the most four significant address bytes and the least four significant address bytes.

```
addressBuffer_w EQU 0xFC00
addressBuffer_t EQU 0x2002
```

Please note that the RAM buffer shall be stored within the SRAM memory dedicated address range which is specified in the HW manual[2].

In addition, the user shall define a variable *buffer* in the application SW as a global variable and use it to force the linker to allocate it. In particular, considering the above example the user shall insert the following declaration:

```
volatile unsigned int buffer[BUTSize]@ 0x2002FC00 = {0};
```

The user, in order to let the compiler allocate the buffer, shall use this variable, using for example the following instruction:

```
buffer[0] = 0;
```

4.4.1.3 Place Result Variables

The SW stores the result of the test in two unused RAM locations accessible from the application code by using two variables (*resultTestRam1* and *resultTestRam2*).

These two variables have to be placed at two absolute addresses of the RAM.

Declaration of these two variables is defined in *testRAM.h* file.

Considering the case of 192KB RAM divided in blocks of 1KB each, we have for example:

- *resultTestRam1* is placed in the last double word location of the block 0;
- *resultTestRam2* is placed in the last double word location of the block 2.

Code in *testRAM.c* file then has to be as follows:

- `unsigned int resultTestRam1 @ 0x20000000 = (unsigned int) 0;`
- `unsigned int resultTestRam2 @ 0x20000800 = (unsigned int) 0;`

4.4.1.4 Word Length

- The chosen RAM algorithm runs using a 32 bit word length.

4.4.1.5 Test Flow and Check Test Results

It is recommended to initially run a destructive test on the buffer. Note that the buffer test has the same result if it is run as destructive or non-destructive; its content are lost.

A recommended flow for the RAM Test is as follows

1. run *testRAM* function on the buffer block;
2. run *testRAM* function on the other blocks of the RAM.

Consider the following instructions to effectively use the *testRAM* function.

1. Include *testRAM.h*
2. Define input variables for parameters to call *testRAM*
 - d. *index*
 - e. *select Algorithm*
 - f. *destructive*
3. Call *testRAM*
4. Check result variables

Worked Example:

```
#include " testRAM.h"

unsigned int index = 71;
unsigned int selectAlgorithm = 0;
unsigned int destructive = 0;

testRAM(index, selectAlgorithm, destructive);

if(!(resultTestRam1&&resultTestRam2)){ /*Fault detection*/
    errorHandler();
}
```

After the *testRAM* function returns, a fault can be detected by checking the output value as shown in the example above.

Note that the output of *testRAM* is stored in two locations, so if *resultTestRam1* and *resultTestRam2* are both equal to 1 no faults are detected, otherwise fault handling management should start (calling of *errorHandler()* function in the above example).

4.4.2 Usage Conditions

Table 4.3 summarises usage conditions.

¹ Not algorithm specific value, just used as example.

Table 4.3 Conditions of use

| ID | Topic | Constraint | Description |
|----|---------------------|--|--|
| 1 | Interrupt | Avoid corruption of function context. | When interrupting the RAM Software Test the context of all General Purpose Registers, system register, including PSR and FAULTMASK, have to be saved and restored once returning from interrupt handling. See Document Reference [1] for details of the CPU register definitions. |
| 2 | CPU mode | Correct execution of the SW. | Launch RAM Software Test in Privileged mode. |
| 3 | Stack | Avoid corruption of the stack. | Test RAM blocks corresponding to stack locations in a non-destructive way. |
| 4 | Environment | Avoid corruption of variables used to check test results. | In any application code other than the SW test do not overwrite values of <i>resultTestRam1</i> and <i>resultTestRam2</i> variables. |
| 5 | Environment | Avoid data lost | Keep in mind that that data saved by the application inside the buffer will be lost when calling the RAM test. |
| 6 | Configuration | Avoid data lost | Do not place the result variables (<i>resultTestRam1</i> and <i>resultTestRam2</i>) in the same block as the buffer. |
| 7 | Configuration | Compliance with SW test strategy | Minimum number of blocks in which RAM is divided has to be 4. |
| 8 | Configuration | Compliance with SW test strategy | Range of addresses of the memory under test has to be double word aligned. |
| 9 | Configuration | Compliance with SW test strategy | For BUTSize respect the following: $BUTSize = MUTSize / 2^x$ with $1 < x \leq \log_2(MUTSize)$ |
| 10 | Configuration | Compliance with SW test strategy | Place <i>resultTestRam1</i> and <i>resultTestRam2</i> variables in two different blocks of the RAM. |
| 11 | Diagnostic coverage | Use sufficient block size to guarantee diagnostic coverage value | Both RAM Tests are giving medium coverage (90%) for permanent faults. This coverage value is valid under the condition that for both tests the minimum block size chosen for the test is not lower than 512 bytes. |

4.5 Define Directives for Software Configuration

Before compiling the code it is necessary to define the size of the RAM under test, the size of the blocks into which the memory is divided and the word length for the executed RAM test algorithm.

All this information is specified by the directives described in Table 4.4.

Table 4.4 Define directives

| Directives | Description |
|------------|--|
| MUTSize | Indicate the size of the RAM under test. Value associated to it expresses size of the RAM in terms of double words. This setting has to be in <i>testRAM.h</i> |
| BUTSize | Indicate the size of the blocks in which the RAM is divided. Value assigned to it has to be of this type: MUTSize/4; MUTSize/8; MUTSize/16; MUTSize/32; ... ; MUTSize/MUTSize This value is always in terms of double words. This setting has to be in <i>testRAM.h</i> |

4.6 Software Package Description

This section details how to identify the supplied software package, including its MD5 signature and also provides a description in tabular format for each design file type.

4.6.1 Identification and Contents of Package

The Software package version is identified as follows:

- Revision 1.0.1
- File list

Table 4.5 RAM Package and related MD5 signatures

| Nome File | MD5 Signature |
|-------------------------|----------------------------------|
| extendedMarchCminus.asm | aeb6759009a900302e55015424d3a658 |
| extendedMarchCminus.h | eddc772135ebb62c03536ce7649b9b82 |
| testRAM.c | fd62c5f03c3980735eb17e618fa0f8 |
| testRAM.h | f161c9d0def145951ff3ea9a8e6230c8 |
| testRAM.inc | 393296054a1395d1f664639a901ec2d0 |
| walpat.asm | 6219b823cdd280d1aae4f85d6cbe2cb5 |
| walpat.h | 7c3e9770144a6d0eeba3568fca019c07 |

4.6.2 Description of Design Files

Table 4.6 Design files

| Table ID | File Name | Description |
|----------|-------------------------|--|
| 1 | testRAM.h | This file contains the API of the RAM test. In particular contains the <i>testRAM</i> function declaration to be called by the application SW. Also it contains declaration of the result variables placed at fixed absolute addresses and define directives |
| 2 | testRAM.c | This file contains the definition of <i>testRAM</i> function. |
| 3 | extendedMarchCminus.h | This file contains the declaration of the Extended March C- algorithm function. |
| 4 | extendedMarchCminus.asm | This file contains the definition of the Extended March C- algorithm function. |
| 5 | walpat.h | This file contains the declaration of the WALPAT algorithm function. |
| 6 | walpat.asm | This file contains the definition of the WALPAT algorithm function. |
| 7 | testRAM.inc | This file contains the definition of the patterns for the test execution. |

4.7 Resources Usage

Table 4.7 provides an overview of the memory resources used by the code.

The Maximum stack usage is 0bytes.

Table 4.7 Memory resources

| Module | ROM | | RAM (bytes) |
|-----------------------|--------------|--------------|-------------|
| | Code (bytes) | Data (bytes) | |
| extendedMarchCminus.o | 468 | 0 | 0 |
| testRAM.o | 120 | 0 | 8 |
| walpat.o | 468 | 0 | 0 |
| Total (bytes) | 1056 | 0 | 8 |

The timing performance details in Table 4.8 below, are referenced to the test of one RAM block with a size of 1Kb.

Table 4.8 Execution time

| Algorithm | NON-Destructive | NON-Destructive | Destructive | Destructive |
|-------------------|-------------------------------|---------------------------------|-------------------------------|---------------------------------|
| | Execution time [clock cycles] | Execution time@48MHz clock [us] | Execution time [clock cycles] | Execution time@48MHz clock [us] |
| Extended March C- | 93476 | 1947 | 91176 | 1899,50 |
| WALPAT | 7911754 | 164828 | 7909448 | 164780,17 |

4.8 Requirements for Safety Relevant Applications

Table 4.9 lists recommendations for usage in safety relevant applications.

Table 4.9 Safety relevant requirements

| ID | Topic | Sub-topic | Description |
|----------|---------------|------------------|--|
| RAM_SW_1 | Test flow | Buffer | Before testing blocks other than buffer test the buffer with a destructive testing. Rationale is to avoid corruption of the test result because of a faulty buffer. |
| RAM_SW_2 | Configuration | Number of blocks | Consider to divide the memory under test into a minimum number of blocks, possibly equals to 4. Rationale is to properly detect address faults mainly: the larger the block more efficient the address fault detection. |

5. ROM Software Test

5.1 Test Objectives

The objective of the ROM Software Test is to verify the embedded ROM memory of the MCU.

The main features of the software tests are as follows.

- Whole memory check.
- Possibility to test with a block-wise strategy, generating multiple CRC signatures.
- Support of three CRC polynomials.
- Support of incremental mode calculation: calculation of the CRC signature can be time-wise split.

5.2 Test Strategy

The scope of the ROM Software Test is to verify the embedded ROM using a CRC technique. Error detection is achieved as follows:

1. A range of ROM addresses is chosen; this step defines the block under test.
2. A reference checksum value is calculated using the IAR linker and saved inside the memory.
3. During the ROM Software Test execution, the hardware peripheral CRC Calculator (see Document Reference [2] for the peripheral details) is used to produce an actual checksum value of the ROM under test in order to check its integrity.
4. The calculated Checksum value is compared with that stored in memory and an error is detected if the two values do not match.
5. The previous steps are repeated for a different block of memory until the whole ROM area is covered.

5.2.1 Checksum Generation using the IAR linker

Before compiling the ROM Software Test, checksum generation by the IAR linker has to be enabled.

Furthermore, the following information has to be considered.

1. Place a checksum variable for each ROM addresses range under test
2. Start and End addresses of the ROM without considering the location in which checksum value is placed
3. Size and alignment of the checksum variable
4. Initial value of the checksum variable
5. The checksum algorithm used (chosen polynomial)
6. Checksum variable bit order

Further details are provided in Section 5.5

5.2.2 MCU CRC Peripheral

The CRC calculator (refer to Document Reference [2] for peripheral details) generates CRC codes for data blocks. It provides the use of any of the three polynomials listed below.

- 8-bit CRC

- 1. x^8+x^2+x+1
- 16-bit CRC
 - 2. $x^{16}+x^{15}+x^2+1$
 - 3. $x^{16}+x^{12}+x^5+1$

5.3 Top Level Software Structure

Two functions are used to run the CRC calculator module and generate the checksum value

- *crcHwSetup* enables the CRC HW module and configures the control registers to select the selected CRC polynomial to be used
- *crcComputation* calculates checksum on all the bytes of the selected ROM block.

5.3.1 ROM Test APIs

The function signatures are found below

void crcHwSetup(unsigned int crc)

uint16_t crcComputation(unsigned int checksumBegin, unsigned int checksumEnd, unsigned int incrMode)

Table 5.1 describes more details of the interface to the functions.

Table 5.1 ROM test APIs

| Table ID | Function | Parameter type | C type | Name | Description |
|----------|-----------------------|----------------|--------------|----------------------|---|
| 1 | <i>crcHwSetup</i> | input | unsigned int | <i>crc</i> | Specify the kind of CRC generating polynomial: -“0”: x^8+x^2+x+1 (8-bit CRC) -“1”: $x^{16}+x^{15}+x^2+1$ (16-bit CRC) -“2”: $x^{16}+x^{12}+x^5+1$ (16-bit CRC) -other values: default is 16-bit CRC $x^{16}+x^{15}+x^2+1$ |
| 2 | <i>crcComputation</i> | input | unsigned int | <i>checksumBegin</i> | Specify ROM block start address. |
| 3 | <i>crcComputation</i> | input | unsigned int | <i>checksumEnd</i> | Specify ROM block end address. |
| 4 | <i>crcComputation</i> | input | unsigned int | <i>incrMode</i> | Specify the CRC calculation mode: -“0”: incremental mode not active - other values: incremental mode active |
| 5 | <i>crcComputation</i> | output | uint16_t | - | The return value of the function is the computed checksum value. |

Note that within the *crcComputation* function

- The CRC signature is initialized to 0xff in case of CRC_8 utilization or 0xffff in case of CRC_16 or CRC_16_CCITT.
- The return value is the 1’s complement of the calculated checksum.

Note also that the block size of the memory for the CRC calculation is defined by the difference between the end and the start addresses and it has to be a multiple of the CRC length.

5.3.2 Incremental Mode Calculation

The input parameter *incrMode* allows the user to split the calculation of the CRC signature for the same ROM block in the best way depending on the requirements of its application.

The behaviour is summarized in Figure 5.1:

- the ROM block for which the CRC is to be calculated is divided in sub-blocks identified by a given set of addresses (3 group of addresses in the example);
- then *crcComputation* is run on each set of addresses;
- the first call of *crcComputation* is made with no incremental mode while the following calls need to have the incremental mode active in order to “accumulate” previous partial results;
- after the last function call the total block CRC is returned.

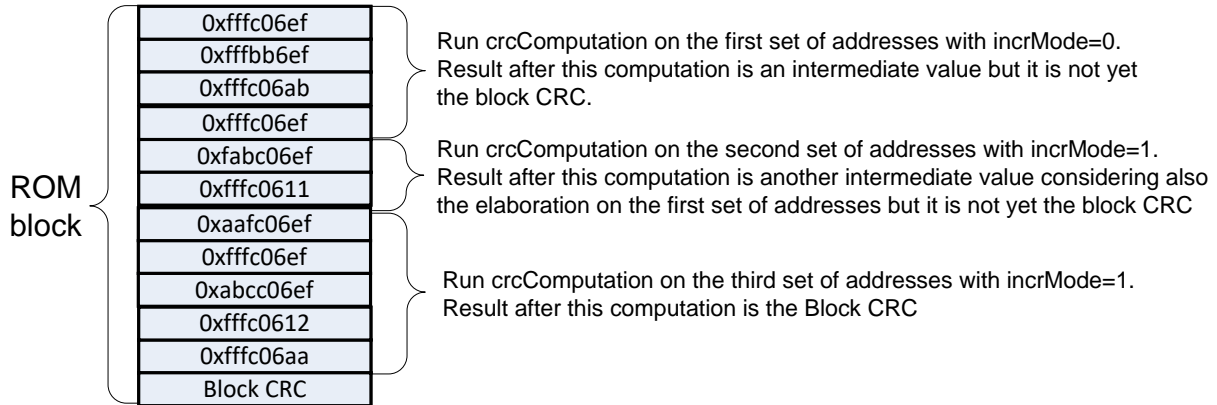


Figure 5.1 Incremental mode calculation

5.4 Software Integration Rules

5.4.1 Code Integration

Follow the instructions below to call the ROM test functions:

1. Include *crc.h*
2. Define extern variables for each CRC signatures generated by the IAR linker and placed in ROM.
3. Define variable for input parameter of *crcHwSetup*:
 - a. *crcType*
4. Define variables for input parameter of *crcComputation*:
 - a. *checksumBegin*
 - b. *checksumEnd*
 - c. *incrMode*
5. Define output variable in order to store the result of the *crcComputation*.

Refer to the example in Section 5.4.2.1 which explains a case in which two ROM addresses ranges are tested.

5.4.2 Test Flow and Test Results Check

The recommended test flow is as follows:

1. Initialize the peripheral using *crcHwSetup*.
2. Evaluate the checksum using *crcComputation*.
3. Compare with expected checksum for error detection

5.4.2.1 Worked Example

```
#include "crc.h"
extern const uint16_t __checksum;

unsigned int type = 1;
crcHwSetup(type);

unsigned int checksumStart = 0x00000000;
unsigned int checksumStop = 0x000FFFFB;
unsigned int crcIncr = 0;
uint16_t crcResult;
crcResult = crcComputation(checksumStart, checksumStop, crcIncr);
if(crcResult != __checksum){
    errorHandler();
}
```

After *crcComputation* function returns, a fault can be detected by checking the output value as shown in the example above: *crcResult* achieved by the ROM Software Test is compared with *__checksum*, that is the reference value computed by the IAR linker.

5.4.2.2 Worked Example with Incremental Mode

```
#include "crc.h"

extern const uint16_t _checksum;

unsigned int type;
unsigned int checksumStart;
unsigned int checksumStop;
uint16_t crcResult;
unsigned int crcIncr;

type = 1;
crcHwSetup(type);

crcIncr = 0;
checksumStart = 0x00000000;
checksumStop = 0x0007FFFB;           //512KB
crcResult = crcComputation(checksumStart, checksumStop, crcIncr);

crcIncr = 1;
checksumStart = 0x00080000;
checksumStop = 0x000FFFFB;           //512KB
crcResult = crcComputation(checksumStart, checksumStop, crcIncr);

if(crcResult != __checksum){
    errorHandler();
}
```

The above example shows how the CRC for a 1MB block can be calculated with 2 cumulated runs of the *crcComputation* function.

Note that the *crcResult* is compared with the value computed by the IAR linker only after the last call of the *crcComputation* function.

The above example also shows the 2 calls of the *crcComputation* function are sequential, however this is not a definitive requirement. The calls can be executed in a different order as long as the usage conditions described in section 5.4.3 are maintained.

5.4.3 Usage Conditions

Table 5.2 summarises usage conditions.

Table 5.2 Conditions of use

| ID | Topic | Constraint | Description |
|----|------------------|---|--|
| 1 | Interrupt | Avoid corruption of function context. | When interrupting the ROM Software Test the context of all General Purpose Registers, system register, including PSR and FAULTMASK, have to be saved and restored once returning from interrupt handling. See Document Reference 1 for details of the CPU register definitions. |
| 2 | Incremental mode | Avoid corruption of the calculated CRC value. | When the incremental mode is used do not change the setting or neither use the HW peripheral CRC Calculator until the CRC calculation is completed. This is valid for any kind of SW (e.g. application SW or any interrupt handlers). |

5.5 Checksum Generation Using IAR Tools

The ROM Test requires a reference checksum for each addresses range under test. The reference checksum is necessary for comparison with that computed by the CRC calculator.

To ensure accurate control of the error detection performance of the code, it may be necessary to generate multiple checksums.

This section shows how to use the IAR Embedded Workbench for ARM version 8.23.1.17132 to generate the checksum.

The process is outlined in the three steps below.

1. Provide information to the IAR linker as to where to place checksum values. Provide also information about symbols for the start and end addresses of the ROM blocks under test.
2. Use the IAR graphic interface to perform the checksum calculation.
3. In the .icf file, define memory ranges where the checksum values should be placed.

A worked example is provided below, which gives additional clarification for how to use the IAR Tools to generate the required CRCs.

5.5.1 Example Checksum Generation with IAR Tools

Assume the ROM Test addresses range is

- 0x00000000- 0x000FFFFB

and a checksum is required to be generated using the polynomial $x^{16}+x^{12}+x^5+1$ (16-bit CRC-16CCITT)

1. Go to “Project > Options... > Linker > Checksum” and set the following parameters:
 - a. Select “Fill unused code memory” option
 - b. File pattern = 0x00
 - c. Start Address = 0x00000000
 - d. End address = 0x000FFFFB
 - e. Select "Generate checksum" option
 - f. Checksum size = 2 bytes
 - g. Alignment = 1
 - h. Algorithm = CRC polynomial, 0x1021
 - i. Bit order = MSB
 - j. Initial value = 0xFFFF
 - k. Checksum unit size = 8 bit.

2. In the .icf file, define memory ranges and locations of the checksums:

```
define symbol __ICFEDIT_region_ROMuT_start__ = 0x00000000;
define symbol __ICFEDIT_region_ROMuT_end__ = 0x000FFFFB;

define region CHECKSUM_region = mem:[from __ICFEDIT_region_ROMuT_start__ to
__ICFEDIT_region_ROMuT_end__];
place at end of CHECKSUM_region { ro section .checksum };
```

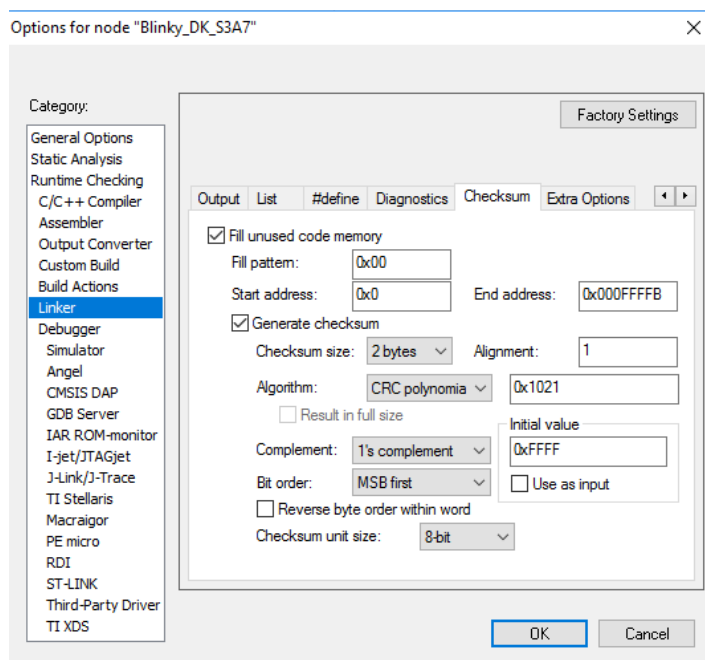


Figure 5.2 IAR Environment Options

For more information about these commands refer to Document Reference 3.

5.6 Software Package Description

This section details how to identify the supplied software package and also provides a description in tabular format for each design file type.

5.6.1 Identification and Contents of Package

The Software package version is identified as follows:

- Revision 1.0.1
- File list

Table 5.3 ROM Package and related MD5 signatures.

| Nome File | MD5 Signature |
|------------------|----------------------------------|
| crc.c | d9e82f13ce28208b4d1d2ae25314037d |
| crc.h | a1277077fe417c19f3a844eb747d67d5 |
| S3A7_registers.h | 81c2f1f7d053743283a1debb70f5ecc4 |

5.6.2 Description of Design Files

Table 5.4 Design files

| Table ID | File Name | Description |
|----------|------------------|--|
| 1 | crc.h | <ul style="list-style-type: none"> • This file contains the declaration of the two functions for the crc calculator: <ul style="list-style-type: none"> • <i>crcHwSetup</i>: It initializes CRC module; • <i>crcComputation</i>: It runs CRC on the specified ROM block. |
| 2 | crc.c | This file contains the definition of the two functions declared in the file <i>crc.h</i> . |
| 3 | S3A7_registers.h | This file contains the definitions of the needed peripherals registers. |

5.7 Resources Usage

Table 5.5 provides an overview of the memory resources used by the code.

Maximum stack usage is 0 bytes.

Table 5.5 Memory resources

| Module | ROM | | RAM (bytes) |
|----------------------|--------------|--------------|-------------|
| | Code (bytes) | Data (bytes) | |
| crc.o | 232 | 0 | 4 |
| Total (bytes) | 232 | 0 | 4 |

Table 5.6 illustrates the execution time for calculating a CRC using the polynomial $x^{16}+x^{15}+x^2+1$ with a block size of 4Kb.

Table 5.6 Execution time

| Function | Execution time for a ROM block size of 4Kb [clock cycles] | Execution time for a ROM block of 4Kb @48MHz clock [us] |
|----------------|--|---|
| crcComputation | 49188 | 1024,7 |

5.8 Requirements for Safety Relevant Applications

Table 5.7 lists recommendations for usage in safety relevant applications.

Table 5.7 Safety relevant requirements

| ID | Topic | Sub-topic | Description |
|----------|--------------|-----------|--|
| ROM_SW_1 | CRC type | - | Adopt the following CRC16 polynomial $x^{16}+x^{15}+x^2+1$ |
| ROM_SW_2 | Block length | - | Use a block size of 4Kbytes |

By following the above mentioned recommendations, it is possible to detect all single and double bit corruptions within one block.

In addition, and regardless of the block size, the use of such a polynomial allows for the detection of an odd number of single bit error, with the following performance in relation to burst error detection, where a burst of length k corresponds to the presence of k consecutive corrupted bits:

- all bursts with length equal and less than 16 bits
- 99.997 percent of bursts of 17 bits
- 99.998 percent of bursts with length greater than 18 bits.

6. CAC Configuration Software

6.1 Test Objectives

The objective of the CAC Configuration Software is to configure the CAC. For safety applications this SW shall be used to:

- Select PCLKB as measurement target clock for the CAC;
- Select Sub-clock oscillator as measurement reference clock for the CAC.

This configuration allows to detect deviations of the Main clock oscillator and PLL due to systematic or random hardware failures.

The CAC Configuration Software also enable the Synergy S3 Oscillation Stop Detection Circuit functionality. This circuit, in case the main clock stops, is in charge to switch to the Middle-Speed On-Chip oscillator and generate an NMI interrupt.

6.2 Test Strategy

The test strategy is to configure the CAC peripheral to monitor PCLKB clock using Sub-clock oscillator.

If the frequency of the monitored clock deviates during runtime from a configured range two types of interrupt can be generated: frequency error interrupt or an overflow interrupt. The user of this module must enable these two kinds of interrupt and handle them.

Note also that it is demanded to the user to enable the Sub-clock oscillator through the SOSCCR register (i.e. SOSCCR.SOSTP = 0b, see User Manual [1]), otherwise the monitoring will not work.

The allowable frequency range is evaluated according to the following equations:

CAULVR (Upper Limit Value) can be computed by rounding down the result from the following equation and converting it into a hexadecimal value:

$$CAULVR = \text{floor} \left(\frac{\left(\frac{PCLKB}{CLKT_{DIV}} * \left(1 + 1 - \frac{DC}{100} \right) \right)}{\frac{CLK_{ref}}{CLKR_{DIV}}} \right)$$

Equation 1

CALLVR (Lower Limit Value) can be computed by rounding up the result from the following equation and converting it into a hexadecimal value:

$$CALLVR = \text{ceil} \left(\frac{\left(\frac{PCLKB}{CLKT_{DIV}} * \left(\frac{DC}{100} \right) \right)}{\frac{CLK_{ref}}{CLKR_{DIV}}} \right)$$

Equation 2

With parameters having the meaning reported in Table 6.1.

Table 6.1 parameters description for CAULVR, CALLVR

| Parameter | Description | Unit |
|---------------------|--|------|
| PCLKB | Frequency of the peripheral module clock B | MHz |
| DC | Target diagnostic coverage | % |
| CLK _{ref} | Frequency of the reference clock. This is based on the Sub-clock oscillator frequency (32.768 kHz) considering the accuracy of the selected external crystal | MHz |
| CLKT _{DIV} | Division as per Measurement Target Clock Frequency Division Ration Select (TCSS) register | - |
| CLKR _{DIV} | Division as per Measurement Reference Clock Frequency Division Ration Select (RCDS) register | - |

In addition to the CAC function the Synergy S3 has an Oscillation Stop Detection Circuit. If the main clock stops, the Middle-Speed On-Chip oscillator will automatically be used instead and an NMI interrupt will be generated. The User of this module must handle the NMI interrupt and check the NMISR.OSTST bit.

6.3 CAC Configuration Software API

The function signatures are found below

```
void ClockMonitor_Init(double target_clock_frequency, target_clk_div_t target_clock_division,
```


reference_clk_div_t reference_clock_division, double dc, CLOCK_MONITOR_ERROR_CALL_BACK Callback);

Table 6.2 describes more details of the interface to the functions.

Table 6.2 CAC Configuration Software APIs

| Table ID | Function | Parameter type | C type | Name | Description |
|----------|-------------------|----------------|-------------------------------|--------------------------|--|
| 1 | ClockMonitor_Init | Input | double | target_clock_frequency | The target clock frequency in Hz |
| 2 | ClockMonitor_Init | Input | target_clk_div_t | target_clock_division | The target clock division to be set. |
| 3 | ClockMonitor_Init | Input | reference_clk_div_t | reference_clock_division | The reference clock division to be set. |
| 4 | ClockMonitor_Init | Input | double | dc | The diagnostic coverage in percentage. |
| 5 | ClockMonitor_Init | Input | CLOCK_MONITOR_ERROR_CALL_BACK | CallBack | Function to be called if the main clock deviates from the allowable range. |

In particular, referring to formulas parameters described in Table 6.1, the function parameters are mapped as the following:

- target_clock_frequency = PCLKB;
- target_clock_division = CLKTDIV;
- reference_clock_division = CLKRDIV;
- dc = DC.

6.4 Software Integration Rules

This section provides guidelines for how to integrate the CAC Configuration Software within the user's own project.

6.4.1 Code Integration

Follow the instructions below to call the CAC Configuration Software functions:

1. Include *clock_monitor.h*
2. Define variables for input parameters of *ClockMonitor_Init*:
 - a. *target_clock_frequency*
 - b. *target_clock_division*
 - c. *reference_clock_division*
 - d. *dc*
 - e. *CallBack*

Refer to the example in Section 6.4.2 which explains how to use the Diagnostic SW.

6.4.2 Usage Conditions

The monitoring of the PCLKB clock is set-up with a single function call to *ClockMonitor_Init*.

For example:

```
#define TARGET_CLOCK_FREQUENCY_HZ          (3000000) // PCLKB: 3MHz (PLL
clock/16)

#define DC (90) // Diagnostic Coverage: 90%

target_clk_div_t target_div = TAR_NO_DIVISION;
reference_clk_div_t ref_div = REF_DIV_32;

/*Enable Sub-Clock*/
PRCR_reg->PRCR = 0xA501;
SOSCCR_reg->SOSCCR_b.SOSTP = 0;
PRCR_reg->PRCR = 0xA500;

ClockMonitor_Init(TARGET_CLOCK_FREQUENCY_HZ, target_div, ref_div, DC,
CAC_Error_Detected_Loop);
```

The clock monitoring is then performed by hardware and so there is nothing that needs to be done by software during the periodic tests.

In order to enable interrupt generation by the CAC, then both Interrupt Controller Unit (ICU) and Cortex-M4 Nested Vectored Interrupt Controller (NVIC) shall be configured in order to handle it.

For configuring the ICU it is necessary to set the ICU Event Link Setting Register (IELSRn) to the event signal number correspondent to the CAC frequency error interrupt (CAC_FERRI = 0x87) and CAC overflow (CAC_OVFI = 0x89). In particular, it is necessary to configure one IELSR register so that it is linked to the aforementioned CAC events:

```
IELSRn.IELS = 0x87; // (CAC_FERRI)
IELSRn.IELS = 0x89; // (CAC_OVFI)
```

In addition, in order to enable the Cortex-M4 NVIC to handle the CAC interrupts, the following instructions shall be set:

```
NVIC_EnableIRQ(CAC_FREQUENCY_ERROR_IRQn);
NVIC_EnableIRQ(CAC_OVERFLOW_IRQn);
```

Where CAC_FREQUENCY_ERROR_IRQn and CAC_OVERFLOW_IRQn are the IRQ number that shall be defined by the user².

If oscillation stop is detected an NMI interrupt is generated. User code must handle this NMI interrupt and check the NMISR.OSTST flag as shown in this example:

² See Table 2-16 of “Cortex-M4 Devices: Generic User Guide”, first release, 16 December 2010 for more details about IRQ numbers.

```

if(1 == R_ICU->NMISR_b.OSTST)
{
    Clock_Stop_Detection();

    /*Clear OSTST bit by writing 1 to NMICLR.OSTCLR bit*/
    R_ICU->NMICLR_b.OSTCLR = 1;
}

```

The OSTDCR.OSTDF status bit can then be read to determine the status of the main clock.

6.5 Define Directives for Software Configuration

No specific directive are present for CAC Configuration Software.

6.6 Software Package Description

This section details how to identify the supplied software package, including its MD5 signature and also provides a description in tabular format for each design file type.

6.6.1 Identification and Contents of Package

The Software package version is identified as follows:

- Revision 1.0.2
- File list

Table 6.3 CAC Configuration Software Package and related MD5 signatures.

| Nome File | MD5 Signature |
|------------------|----------------------------------|
| clock_monitor.c | f153ca66e616dfa2db8a8e120634f905 |
| clock_monitor.h | 430c7cae882468d4910b4921b18d568e |
| S3A7_registers.h | 4954a0eacdc1b4401f7899735db230cc |

6.6.2 Description of Design Files

Table 6.4 Design files

| Table ID | File Name | Description |
|----------|------------------|--|
| 1 | clock_monitor.h | This file contains the declaration of the <i>ClockMonitor_Init</i> function for the monitoring initialization. |
| 2 | clock_monitor.c | This file contains the definition of <i>clock_monitor</i> function. |
| 3 | S3A7_registers.h | This file contains the definitions of the needed peripherals registers. |

6.7 Resources Usage

Table 6.5 provides an overview of the memory resources used by the code.

Maximum stack usage is 120 bytes for both the versions.

Table 6.5 Memory resources

| Module | ROM | | RAM (bytes) |
|----------------------|--------------|--------------|-------------|
| | Code (bytes) | Data (bytes) | |
| clock_monitor.o | 716 | 16 | 4 |
| Total (bytes) | 716 | 16 | 4 |

Table 6.6 illustrates the execution time.

Table 6.6 Execution time

| Function | Clock Cycle Count | Time measured (us) @ 48MHz |
|---------------|-------------------|----------------------------|
| Clock_monitor | 2948 | 61,42 |

6.8 Requirements for Safety Relevant Applications

Please refer to the Safety Manual [4].

7. IWDT Management Software

7.1 Test Objectives

A watchdog is used to detect abnormal program execution. If a program is not running as expected the watchdog will not be refreshed by software as it is required to be and will therefore detect an error.

7.2 Test Strategy

The Independent Watchdog Timer (iWDT) module of the Synergy S3 is used for this. It includes a windowing feature so that the refresh must happen within a specified ‘window’ rather than just before a specified time. It can be configured to generate an internal reset or a NMI interrupt if an error is detected. All the configurations for iWDT can be done through OFS0 register whose settings are demanded to the user (see Section 7.4.2 for an example of configuration). A function is provided to be used after a reset to decide if the IWDT has caused the reset.

7.3 IWDT Management Software APIs

The function signatures are found below

void IWDT_Init (void)

void IWDT_Kick (void)

bool IWDT_DidReset (void)

Table 7.1 describes more details of the interface to the functions.

Table 7.1 IWDT Management Software APIs

| Table ID | Function | Parameter type | C type | Name | Description |
|----------|---------------|----------------|--------|------|--|
| 1 | IWDT_DidReset | output | Bool | N/A | Returns true if the iWDT has timed out or not been refreshed correctly. This can be called after a reset to decide if the watchdog caused the reset. |

7.4 Software Integration Rules

7.4.1 Code Integration

Follow the instructions below to call the IWDT Management Software functions:

1. Include *iwdt.h*
2. Define a boolean variable for output of *IWDT_DidReset*.

Refer to the example in Section 7.4.2 which explains how to use the Diagnostic SW.

7.4.2 Usage Conditions

In order to configure the Independent Watchdog it is necessary to set coherently the OFS0 register. The following code can be used to set the value that has to be stored at the OFS0 memory allocation (OFS0 address = 0x00000400)

```

/* IWDT Start Mode Select */
#define IWDTSTRT_ENABLED (0x00000000)
#define IWDTSTRT_DISABLED (0x00000001)

/*Time-Out Period selection*/
#define IWDT_TOP_128 (0x00000000)
#define IWDT_TOP_512 (0x00000001)
#define IWDT_TOP_1024 (0x00000002)
#define IWDT_TOP_2048 (0x00000003)

/*Clock selection. (IWDTCLK/x) */
#define IWDT_CKS_DIV_1 (0x00000000) // 0b0000
#define IWDT_CKS_DIV_16 (0x00000002) // 0b0010
#define IWDT_CKS_DIV_32 (0x00000003) // 0b0011
#define IWDT_CKS_DIV_64 (0x00000004) // 0b0100
#define IWDT_CKS_DIV_128 (0x0000000F) // 0b1111
#define IWDT_CKS_DIV_256 (0x00000005) // 0b0101

/*Window start Position*/
#define IWDT_WINDOW_START_25 (0x00000000)
#define IWDT_WINDOW_START_50 (0x00000001)
#define IWDT_WINDOW_START_75 (0x00000002)
#define IWDT_WINDOW_START_NO_START (0x00000003) /*100%*/

/*Window end Position*/
#define IWDT_WINDOW_END_75 (0x00000000)
#define IWDT_WINDOW_END_50 (0x00000001)
#define IWDT_WINDOW_END_25 (0x00000002)
#define IWDT_WINDOW_END_NO_END (0x00000003) /*0%*/

/*Action when underflow or refresh error */
#define IWDT_ACTION_NMI (0x00000000)
#define IWDT_ACTION_RESET (0x00000001)

/*IWDT Stop Control*/
#define IWDTSTPCTL_COUNTING_CONTINUE (0x00000000)
#define IWDTSTPCTL_COUNTING_STOP (0x00000001)

#define BIT0_RESERVED (0x00000001)
#define BIT13_RESERVED (BIT0_RESERVED << 13)
#define BIT15_RESERVED (BIT0_RESERVED << 15)

#define OFS0_IWDT_RESET_MASK (0xFFFF0000)

/*This define is used to configure the iWDT peripheral*/
#define OFS0_IWDT_CFG (BIT15_RESERVED | BIT13_RESERVED | BIT0_RESERVED |
(IWDTSTRT_ENABLED << 1) | (IWDT_TOP_1024 << 2) | (IWDT_CKS_DIV_1 << 4) |
(IWDT_WINDOW_END_NO_END << 8) | (IWDT_WINDOW_START_NO_START << 10) |
(IWDT_ACTION_RESET << 12) | (IWDTSTPCTL_COUNTING_CONTINUE << 14))

```

The value `OFS0_IWDT_CFG` shall be stored at the `OFS0` address at compile time in order to configure the Independent Watchdog. In particular, the example enables the iWDT setting a time-out period of 1024 clock cycles at `IWDTCLK/1` clock frequency and counting also during sleep mode of the microcontroller. The example does not set any start/end of watchdog window and configure a reset in case of watchdog expiration.

The Independent Watchdog should be initialized as soon as possible following a reset with a call to `IWDT_Init`:

```
/*Setup the Independent WDT.*/
IWDT_Init();
```

After this the watchdog must be refreshed regularly enough so as to stop the watchdog timing out and performing a reset. Note, if using windowing the refresh must not just be regular enough but also timed to match the specified window. A watchdog refresh is called by calling this:

```
/*Regularly kick the watchdog to prevent it performing a reset. */
IWDT_Kick();
```

If the watchdog has been configured to generate an NMI on error detection then the user must handle the resulting interrupt.

If the watchdog has been configured to perform a reset on error detection then following a reset the code should check if the IWDT caused the watchdog by calling IWDT_DidReset:

```
if(TRUE == IWDT_DidReset())
{
    /*todo: Handle a watchdog reset.*/
    while(1){
        /*DO NOTHING*/
    }
}
```

7.5 Define Directives for Software Configuration

No specific directive are present for IWDT Management Software.

7.6 Software Package Description

This section details how to identify the supplied software package and also provides a description in tabular format for each design file type.

7.6.1 Identification and Contents of Package

The Software package version is identified as follows:

- Revision 1.0.1
- File list

Table 7.2 - iWDT Package and related MD5 signatures

| Nome File | MD5 Signature |
|------------------|----------------------------------|
| iwdt.c | 88f269058ed774c81f570571a1de1470 |
| iwdt.h | 16413964d46e91cc1ddb39c0724d9baa |
| S3A7_registers.h | c14e2cbb03e58da6bc2a0af960925265 |

7.6.2 Description of Design Files

Table 7.3 Design files

| Table ID | File Name | Description |
|----------|------------------|---|
| 1 | iwdt.h | This file contains the declaration of the functions: <ul style="list-style-type: none"> • <i>IWDT_Init</i>: Initialise the independent watchdog timer. After calling this the <i>IWDT_kick</i> function must then be called at the correct time to prevent a watchdog error. If configured to produce an interrupt then this will be the Non Maskable Interrupt (NMI). This must be handled by user code which must check the <i>NMISR.IWDTST</i> flag; • <i>IWDT_Kick</i>: Refresh the watchdog count. • <i>IWDT_DidReset</i>: Returns true if the iWDT has timed out or not been refreshed correctly. This can be called after a reset to decide if the watchdog caused the reset. |
| 2 | iwdt.c | This file contains the definition of the two functions declared in the file <i>iwdt.h</i> . |
| 3 | S3A7_registers.h | This file contains the definitions of the needed peripherals registers. |

7.7 Resources Usage

Table 5.5 provides an overview of the memory resources used by the code.

Maximum stack usage is 0 bytes.

Table 7.4 Memory resources

| Module | ROM | | RAM (bytes) |
|----------------------|--------------|--------------|-------------|
| | Code (bytes) | Data (bytes) | |
| iwdt.o | 124 | 0 | 0 |
| Total (bytes) | 124 | 0 | 0 |

Table 7.5 illustrates the execution time for the specific functions.

Table 7.5 Execution time

| Function | Clock Cycles Count | Time measured (us) @ 48MHz |
|---------------|--------------------|----------------------------|
| IWDT_Init | 26 | 0,54 |
| IWDT_Kick | 19 | 0,4 |
| IWDT_DidReset | 37 | 0,77 |

7.8 Requirements for Safety Relevant Applications

Please refer to the Safety Manual [4].

8. LVD Configuration Software

8.1 Test Objectives

The Synergy S3 has a Voltage Detection Circuit. This can be used to detect the power supply voltage (Vcc) falling below a specified voltage.

8.2 Test Strategy

The supplied sample code demonstrates using Voltage Detection Circuit 1 to generate a NMI interrupt when Vcc drops below a specified level. The hardware is also capable of generating a reset but this behavior is not supported in the sample code.

8.3 LVD Configuration Software APIs

The function signatures are found below

```
void VoltageMonitor_Init(VOLTAGE_MONITOR_LEVEL eVoltage)
```

Table 8.1 describes more details of the interface to the functions.

Table 8.1 LVD Configuration Software APIs

| Table ID | Function | Parameter type | C type | Name | Description |
|----------|---------------------|----------------|-----------------------|----------|---|
| 1 | VoltageMonitor_Init | input | VOLTAGE_MONITOR_LEVEL | eVoltage | The specified low voltage level. See declaration of enumerated type VOLTAGE_MONITOR_LEVEL in voltage.h for details. |

8.4 Software Integration Rules

8.4.1 Code Integration

Follow the instructions below to call the LVD Configuration Software functions:

1. Include *voltage.h*
2. Define variable for input parameter of *VoltageMonitor_Init*:
 - a. *eVoltage*

Refer to the example in Section 8.4.2 which explains how to use the Diagnostic SW.

8.4.2 Usage Conditions

The Voltage Detection Circuit is configured to monitor the main supply voltage with a call to the *VoltageMonitor_Init* function. This should be setup as soon as possible following a power on reset.

Please note to set the LVD1SR.DET bit to 0 both before calling *VoltageMonitor_init* function and in NMI routine, see Section 8.2.2 of 2 for further details.

Please note to set a voltage threshold *eVoltage* lower than the Vcc nominal value.

The following example sets up the voltage monitor to generate an NMI if the voltage drops below 2.99V.

```
VoltageMonitor_Init(VOLTAGE_MONITOR_LEVEL_4_29);
```

If a low voltage condition is detected an NMI interrupt will be generated that the user must handle:

```
/*Low Voltage LVD1*/
if(1 == R_ICU->NMISR_b.LVD1ST)
{
    Voltage_Test_Failure();

    /*Clear LVD1ST bit by writing 1 to NMICLR.LVD1CLR bit*/
    R_ICU->NMICLR_b.LVD1CLR = 1;
}
```

8.5 Define Directives for Software Configuration

No specific directive are present for LVD Configuration Software.

8.6 Software Package Description

This section details how to identify the supplied software package and also provides a description in tabular format for each design file type.

8.6.1 Identification and Contents of Package

The Software package version is identified as follows:

- Revision 1.0.1
- File list

Table 8.2 LVD Configuration SW Package and related MD5 signatures.

| Nome File | MD5 Signature |
|------------------|----------------------------------|
| S3A7_registers.h | 782352821a80f036e8935af878ca2c53 |
| voltage.c | 9e603c82f245436b6c5460776c5d422e |
| voltage.h | 216b85df72c30b33091ace537404555a |

8.6.2 Description of Design Files

Table 8.3 Design files

| Table ID | File Name | Description |
|----------|------------------|--|
| 1 | voltage.h | This file contains the declaration of the functions for voltage monitor: <ul style="list-style-type: none"> • <i>VoltageMonitor_Init</i>: Initialise and start voltage monitoring. An NMI will be generated if Vcc falls below the specified voltage. |
| 2 | voltage.c | This file contains the definition of the two functions declared in the file <i>voltage.h</i> . |
| 3 | S3A7_registers.h | This file contains the definitions of the needed peripherals registers. |

8.7 Resources Usage

Table 8.4 provides an overview of the memory resources used by the code.

Maximum stack usage is 0 bytes.

Table 8.4 Memory resources

| Module | ROM | | RAM (bytes) |
|----------------------|--------------|--------------|-------------|
| | Code (bytes) | Data (bytes) | |
| voltage.o | 188 | 0 | 0 |
| Total (bytes) | 188 | 0 | 0 |

Table 8.5 illustrates the execution time for the specific functions.

Table 8.5 Execution time

| Function | Clock Cycles Count | Time measured (us) @ 48MHz |
|---------------------|--------------------|----------------------------|
| VoltageMonitor_Init | 25243 | 635 |

8.8 Requirements for Safety Relevant Applications

Please refer to the Safety Manual [4].

9. Appendix A – RAM Test Algorithms

The following algorithm descriptions are related to 1bit-word memory, but they can be applied to m-bit memories (Word-oriented memory test). The extension to m-bit word is discussed in this Appendix.

9.1 Extended March C-

A March Test consists of a finite sequence of elements called March Elements, delimited by a pair of curling brackets ‘{ }’.

A March Element is a finite sequence of operations applied to a cell before moving to the next one.

March Elements are delimited by a pair of rounded brackets ‘()’. The next cell is defined with respect to the addressing order, which can be, ascending (\uparrow), descending (\downarrow) or independent (\downarrow). An operation on a memory cell can be, write 0 (w0), write 1 (w1), read and verify to have read 0 (r0), read and verify to have read 1 (r1).

Extended March C- is represented in Figure 9.1 adopting the notation described above.

$$\{c(w0); \uparrow(r0, w1, r1); \uparrow(r1, w0); \\ \downarrow(r0, w1); \downarrow(r1, w0); c(r0)\}$$

Figure 9.1 Extended March C- Algorithm

The March C- algorithm detects address faults (AFs), stuck at faults (SAFs), transactional faults (TFs) and coupling faults (CFs) and in addition the Extended March C- algorithm also detects stuck open faults (SOFs) and data retention faults (DRF). Its complexity is equal to $11n$ where n is the number of addressing cells of the memory.

9.2 WALPAT

The WALPAT algorithm follows the process listed below

1. Write 0 in all cells;
2. For $i=0$ to $n-1$
3. { complement cell[i];
 - a. For $j=0$ to $n-1, j \neq i$
 - b. { read cell[j]; }
4. read cell[i];
5. complement cell[i]; }
6. Write 1 in all cells;
7. For $i=0$ to $n-1$
8. { complement cell[i];
 - a. For $j=0$ to $n-1, j \neq i$
 - b. { read cell[j]; }
9. read cell[i];
10. complement cell[i]; }

The algorithm allows for the detection and location of address faults (AFs), stuck-at faults (SAFs), transactional faults (TFs), coupling faults (CFs) and sense amplifier recovery faults (SARF). Its complexity is equal to $2n^2$ where n is the number of addressing cells of the memory.

9.3 Word-oriented Memory Test

m -bit memories can be dealt with by repeating each algorithm for a number of times given by:

$$\lceil \log_2 m \rceil + 1$$

For every iteration w1 operation writes a pattern (for instance 00000000) and w0 operation writes the complemented value with respect to that used for w1 (11111111).

Taking into account that the code uses 32bits word access, the algorithm will be repeated 6 times and the following 6 different patterns have to be applied:

```
00000000000000000000000000000000
00000000000000001111111111111111
00000000111111110000000011111111
00001111000011110000111100001111
00110011001100110011001100110011
01010101010101010101010101010101
```


10. Appendix B – CPU Test Example

```
#include "coreTest.h"

uint8_t steps=1;
uint32_t result=0;
uint8_t forceFail = 11;

void errorHandler(void);

void main(void)
{
    coreTestInit(); //init index
    steps=36;
    /* Launch the core test function in order to perform Diagnosis SW*/
    coreTest(steps, forceFail, &result);
    if(result != 1) {
        errorHandler();
    }
}
```

11. Appendix C – Pragmas report

The following table reports the pragmas added in the source code to disable specific checks when using the LDRA tool. Related violations have been reviewed in details and judged as not requiring a change to the code.

Table 6 Pragmas report.

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|-----------|--------------|-----|---|-----------|--------------|
| RAM | testRAM.c | 1.0.1 | 18 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 19 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 20 | <code>/*LDRA_INSPECTED 27 D Variable should be declared static. */</code> | 27D | R.8.7, R.8.8 |
| RAM | testRAM.c | 1.0.1 | 23 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 24 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 25 | <code>/*LDRA_INSPECTED 27 D Variable should be declared static. */</code> | 27D | R.8.7, R.8.8 |
| RAM | testRAM.c | 1.0.1 | 28 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 29 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 30 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 33 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|-----------|--------------|-----|--|-----------|------------|
| RAM | testRAM.c | 1.0.1 | 36 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 38 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 40 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 43 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 45 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 47 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 61 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 63 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 70 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.c | 1.0.1 | 72 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.h | 1.0.1 | 26 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.h | 1.0.1 | 28 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|-----------|--------------|-----|--|-----------|--|
| RAM | testRAM.h | 1.0.1 | 31 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.h | 1.0.1 | 32 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| RAM | testRAM.h | 1.0.1 | 33 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 21 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 24 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 79 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 80 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 81 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 85 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 90 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.c | 1.0.1 | 111 | <code>/*LDRA_INSPECTED 93 S Value is not of appropriate type. V9.5.0 */</code> | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| ROM | crc.h | 1.0.1 | 21 | <code>/*LDRA_INSPECTED 90 S Basic type declaration</code> | 90S | D.4.6 |

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|-----------------|--------------|-----|--|-----------|------------|
| | | | | <code>used. */</code> | | |
| ROM | crc.h | 1.0.1 | 24 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.h | 1.0.1 | 25 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| ROM | crc.h | 1.0.1 | 26 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 66 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 67 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 81 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 83 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 85 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 88 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 90 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 92 | <code>/*LDRA_INSPECTED 90 S Basic type declaration used. */</code> | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 106 | <code>/*LDRA_INSPECTED 90 S Basic</code> | 90S | D.4.6 |

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|---------------------|--------------|-----|---|-----------|--|
| | | | | type declaration used. */ | | |
| CAC | clock_monito r.c | 1.0.2 | 107 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 108 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 109 | /*LDRA_INSPECT ED 93 S Value is not of appropriate type. V9.5.0 */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monito r.c | 1.0.2 | 110 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 111 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 116 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 117 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 118 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 119 | /*LDRA_INSPECT ED 93 S Value is not of appropriate type. */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monito r.c | 1.0.2 | 122 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 123 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|---------------------|--------------|-----|---|-----------|--|
| CAC | clock_monito r.c | 1.0.2 | 124 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 125 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 128 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 129 | /*LDRA_INSPECT ED 93 S Value is not of appropriate type. V9.5.0 */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monito r.c | 1.0.2 | 130 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 131 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 137 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 138 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 139 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 140 | /*LDRA_INSPECT ED 93 S Value is not of appropriate type. */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monito r.c | 1.0.2 | 143 | /*LDRA_INSPECT ED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monito r.c | 1.0.2 | 144 | /*LDRA_INSPECT ED 90 S Basic type declaration | 90S | D.4.6 |

| Package | File | Code Version | Row | Code (Pragma) | LDRA Rule | MISRA Rule |
|---------|-----------------|--------------|-----|---|-----------|--|
| | | | | used. */ | | |
| CAC | clock_monitor.c | 1.0.2 | 147 | /*LDRA_INSPECTED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 148 | /*LDRA_INSPECTED 93 S Value is not of appropriate type. V9.5.0 */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monitor.c | 1.0.2 | 149 | /*LDRA_INSPECTED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 150 | /*LDRA_INSPECTED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monitor.c | 1.0.2 | 176 | /*LDRA_INSPECTED 93 S Value is not of appropriate type. V9.5.0 */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monitor.c | 1.0.2 | 177 | /*LDRA_INSPECTED 93 S Value is not of appropriate type. */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monitor.c | 1.0.2 | 179 | /*LDRA_INSPECTED 93 S Value is not of appropriate type. V9.5.0 */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monitor.c | 1.0.2 | 180 | /*LDRA_INSPECTED 93 S Value is not of appropriate type. */ | 93S | R.10.1, R.10.3, R.10.4, R.10.5, R.11.1 |
| CAC | clock_monitor.h | 1.0.2 | 59 | /*LDRA_INSPECTED 90 S Basic type declaration used. */ | 90S | D.4.6 |
| CAC | clock_monitor.h | 1.0.2 | 60 | /*LDRA_INSPECTED 90 S Basic type declaration used. */ | 90S | D.4.6 |

Document References

1. Cortex-M4 Devices – Generic User Guide, first release, 16/12/2010.
2. Synergy S3 User's Manual: Hardware, Rev. 1.30, February 2018 (Document Reference R01UM0002EU130).
3. IAR C/C++ Development Guide Compiling and linking for Advanced RISC Machines Ltd's ARM Cores, Fifteenth edition, March 2015.
4. Safety Manual, ID=SAF_005_PIA003_S3.

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Revision History

| Rev. | Date | Description | |
|------|--------------|-------------------------|--|
| | | Page | Summary |
| 0.1 | Dec 14, 2016 | All | First version. Porting of SW User Guide of S7G2 (PA015) to S3A7 (PA024) |
| 0.2 | Jan 4, 2017 | References | Moved References section at the bottom. Updated References format. |
| 0.3 | Jan 26, 2017 | §4.4.1.2 | Inserted usage condition to reserve buffer area for RAM non destructive tests. |
| | | 8.4.2 | Added usage condition for LVD SW. |
| 0.4 | Feb 9, 2017 | All | Updated template. |
| 0.5 | Feb 23, 2017 | 8.4.2 | Added usage condition for LVD SW regarding LVD1SR register. |
| | | 10.4.2 | Added consideration about temperature sensor slope. |
| 0.6 | Mar 02, 2017 | 2.1 | Updated C type implementation assumption |
| 0.7 | Jun 09, 2017 | All | Updated MD5 signature for the final code version of each SW baseline. |
| | | | Updated resource usage for each SW code. |
| 1.0 | Jun 14, 2017 | All | Internal approval |
| 1.1 | Mar 14, 2018 | 4.7,5.7 | Updated Walpat execution time and memory resources used by the code crc.o |
| | | 4.4.1 | updated integration strategy of RAM test |
| 1.2 | Jul 17, 2018 | References | Removed revision information from documentation |
| | | 3.6,4.7,5.7,6.7,7.7,8.7 | Corrected Resources usage |
| 1.3 | Sep 27, 2018 | All | Updated the functional safety version of the IAR Embedded Workbench. |
| | | - | Removed "ADC14 Comparator Software" and TSN "Management Software" chapters. |
| | | - | Updated latest release and MD5s of CPU, RAM, ROM, CAC, IWDT and LVD tests. |
| | | All | Replaced "S3A7" Synergy name with "S3". |

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